- **Operating Voltage Range of 4.5 V to 5.5 V**
- **High-Current 3-State True Outputs Can Drive Up To 15 LSTTL Loads**
- **Low Power Consumption, 80-μA Max I_{CC}**
- **Typical t_{pd} = 21 ns**
- **$\pm$6-mA Output Drive at 5 V**
- **Low Input Current of 1 μA Max**
- **Inputs Are TTL-Voltage Compatible**
- **Eight High-Current Latches in a Single Package**
- **Full Parallel Access for Loading**

SN54HCT373 . . .J OR W PACKAGE
SN74HCT373 . . .DB, DW, N, NS, OR PW PACKAGE
(TOP VIEW)

$\overline{OE}$	1	20	V_{CC}
1Q	2	19	8Q
1D	3	18	8D
2D	4	17	7D
2Q	5	16	7Q
3Q	6	15	6Q
3D	7	14	6D
4D	8	13	5D
4Q	9	12	5Q
GND	10	11	LE

SN54HCT373 . . .FK PACKAGE
(TOP VIEW)

Top pins: 1D(3) 1Q(2) $\overline{OE}$(1) V_{CC}(20) 8Q(19)
Left pins: 2D(4) 2Q(5) 3Q(6) 3D(7) 4D(8)
Right pins: 8D(18) 7D(17) 7Q(16) 6Q(15) 6D(14)
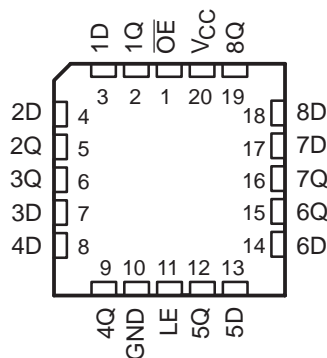Bottom pins: 4Q(9) GND(10) LE(11) 5Q(12) 5D(13)

description/ordering information

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches of the 'HCT373 devices are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels that were set up at the D inputs.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
−40°C to 85°C	PDIP – N	Tube of 20	SN74HCT373N	SN74HCT373N
	SOIC – DW	Tube of 25	SN74HCT373DW	HCT373
		Reel of 2000	SN74HCT373DWR	
	SOP – NS	Reel of 2000	SN74HCT373NSR	HCT373
	SSOP – DB	Reel of 2000	SN74HCT373DBR	HT373
	TSSOP – PW	Tube of 70	SN74HCT373PW	HT373
		Reel of 2000	SN74HCT373PWR	
		Reel of 250	SN74HCT373PWT	
−55°C to 125°C	CDIP – J	Tube of 20	SNJ54HCT373J	SNJ54HCT373J
	CFP – W	Tube of 85	SNJ54HCT373W	SNJ54HCT373W
	LCCC – FK	Tube of 55	SNJ54HCT373FK	SNJ54HCT373FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS

description/ordering information (continued)

An output-enable ($\overline{\text{OE}}$) input places the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

$\overline{\text{OE}}$ does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are off.

FUNCTION TABLE
(each latch)

INPUTS			OUTPUT
$\overline{\text{OE}}$	LE	D	Q
L	H	H	H
L	H	L	L
L	L	X	Q_0
H	X	X	Z

logic diagram (positive logic)

To Seven Other Channels
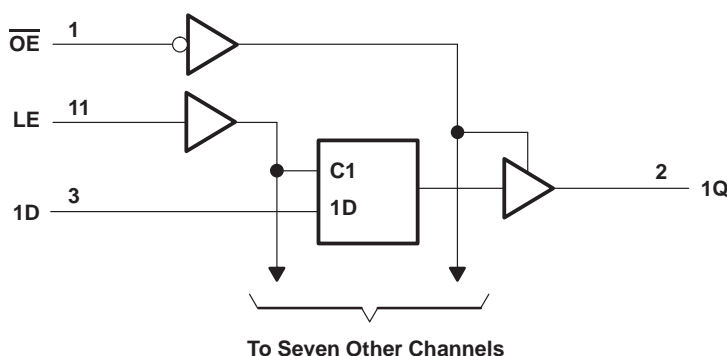
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . −0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) . . . . ±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) . . . . ±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC}) . . . . ±35 mA
Continuous current through V_{CC} or GND . . . . ±70 mA
Package thermal impedance, θ_{JA} (see Note 2): DB package . . . . 70°C/W
DW package . . . . 58°C/W
N package . . . . 69°C/W
NS package . . . . 60°C/W
PW package . . . . 83°C/W
Storage temperature range, T_{stg} . . . . −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

TEXAS INSTRUMENTS

recommended operating conditions (see Note 3)

			SN54HCT373			SN74HCT373			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	V_{CC} = 4.5 V to 5.5 V	2			2			V
V_{IL}	Low-level input voltage	V_{CC} = 4.5 V to 5.5 V			0.8			0.8	V
V_I	Input voltage		0		V_{CC}	0		V_{CC}	V
V_O	Output voltage		0		V_{CC}	0		V_{CC}	V
$\Delta t/\Delta v$	Input transition rise/fall time				500			500	ns
T_A	Operating free-air temperature		−55		125	−40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V_{CC}	T_A = 25°C			SN54HCT373		SN74HCT373		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	V_I = V_{IH} or V_{IL}	I_{OH} = −20 µA	4.5 V	4.4	4.499		4.4		4.4		V
		I_{OH} = −6 mA		3.98	4.3		3.7		3.84		
V_{OL}	V_I = V_{IH} or V_{IL}	I_{OL} = 20 µA	4.5 V		0.001	0.1		0.1		0.1	V
		I_{OL} = 6 mA			0.17	0.26		0.4		0.33	
I_I	V_I = V_{CC} or 0		5.5 V		±0.1	±100		±1000		±1000	nA
I_{OZ}	V_O = V_{CC} or 0		5.5 V		±0.01	±0.5		±10		±5	µA
I_{CC}	V_I = V_{CC} or 0, I_O = 0		5.5 V			8		160		80	µA
ΔI_{CC}†	One input at 0.5 V or 2.4 V, Other inputs at 0 or V_{CC}		5.5 V		1.4	2.4		3		2.9	mA
C_i			4.5 V to 5.5 V		3	10		10		10	pF

† This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V_{CC}	T_A = 25°C		SN54HCT373		SN74HCT373		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_w	Pulse duration, LE high	4.5 V	20		30		25		ns
		5.5 V	17		27		23		
t_{su}	Setup time, data before LE↓	4.5 V	10		15		13		ns
		5.5 V	9		14		12		
t_h	Hold time, data after LE↓	4.5 V	10		10		10		ns
		5.5 V	10		10		10		

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	T_A = 25°C			SN54HCT373		SN74HCT373		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	D	Q	4.5 V		25	35		53		44	ns
			5.5 V		21	32		48		40	
	LE	Any Q	4.5 V		28	35		53		44	
			5.5 V		25	32		48		40	
t_{en}	$\overline{OE}$	Any Q	4.5 V		26	35		53		44	ns
			5.5 V		23	32		48		40	
t_{dis}	$\overline{OE}$	Any Q	4.5 V		23	35		53		44	ns
			5.5 V		22	32		48		40	
t_t		Any Q	4.5 V		10	12		18		15	ns
			5.5 V		9	11		16		14	

switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	T_A = 25°C			SN54HCT373		SN74HCT373		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	D	Q	4.5 V		32	52		79		65	ns
			5.5 V		27	47		71		59	
	LE	Any Q	4.5 V		38	52		79		65	
			5.5 V		36	47		71		59	
t_{en}	$\overline{OE}$	Any Q	4.5 V		33	52		79		65	ns
			5.5 V		28	47		71		59	
t_t		Any Q	4.5 V		18	42		63		53	ns
			5.5 V		16	38		57		48	

operating characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance per latch	No load	50	pF

TEXAS
INSTRUMENTS

PARAMETER MEASUREMENT INFORMATION
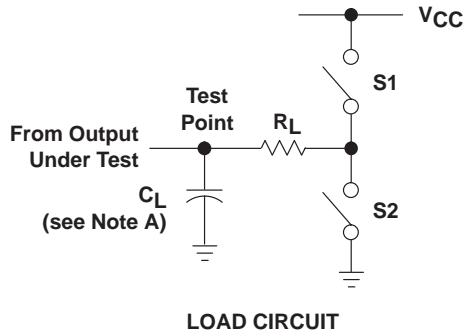
PARAMETER		R_L	C_L	S1	S2
t_{en}	t_{PZH}	1 kΩ	50 pF or 150 pF	Open	Closed
	t_{PZL}			Closed	Open
t_{dis}	t_{PHZ}	1 kΩ	50 pF	Open	Closed
	t_{PLZ}			Closed	Open
t_{pd} or t_t		—	50 pF or 150 pF	Open	Open

LOAD CIRCUIT

VOLTAGE WAVEFORMS
PULSE DURATIONS

VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES

VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT RISE AND FALL TIMES

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS
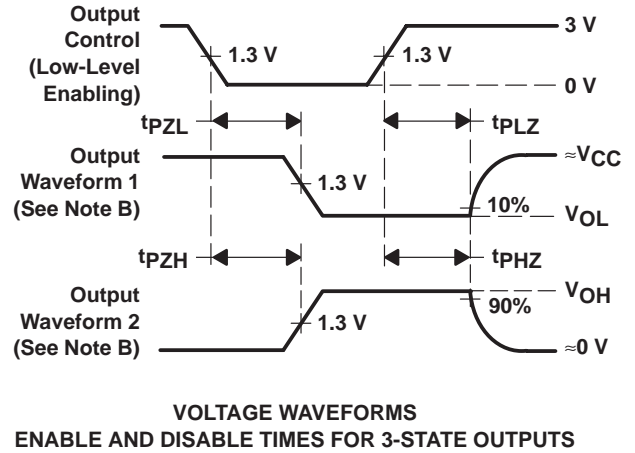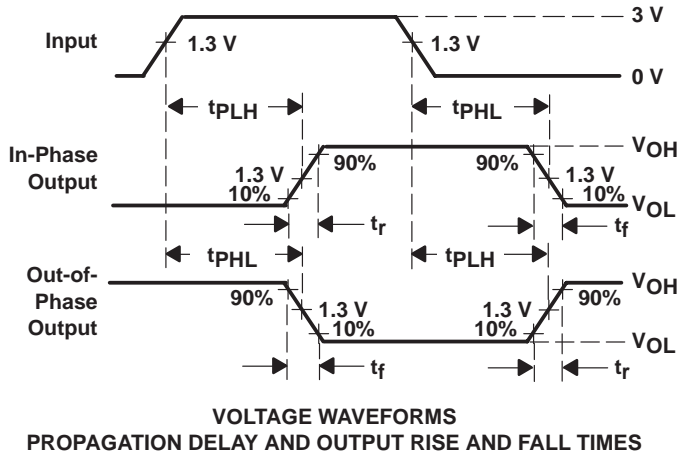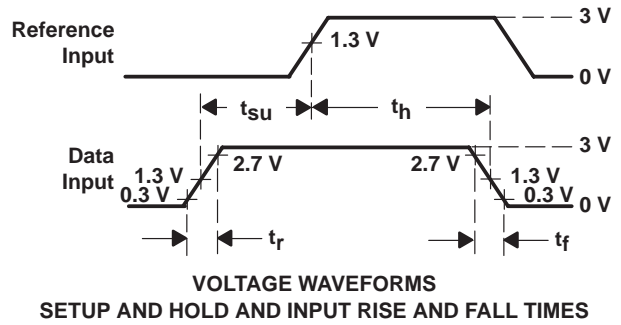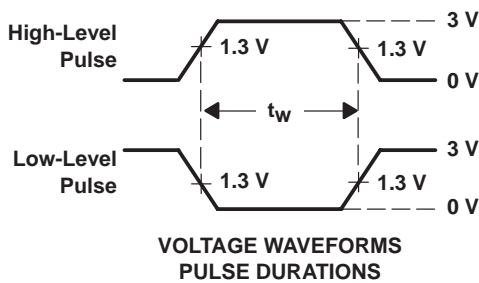
NOTES: A. C_L includes probe and test-fixture capacitance.
   B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
       Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following
       characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r = 6 ns, t_f = 6 ns.
   D. The outputs are measured one at a time with one input transition per measurement.
   E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
   F. t_{PZL} and t_{PZH} are the same as t_{en}.
   G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms

J (R—GDIP—T**)   CERAMIC DUAL IN—LINE PACKAGE
14 LEADS SHOWN

DIM ╲ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

B

14   8

C

1   7

0.065 (1,65)
0.045 (1,14)

0.005 (0,13) MIN

0.060 (1,52)
0.015 (0,38)

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

0.026 (0,66)
0.014 (0,36)

0.100 (2,54)

A

0°—15°

0.014 (0,36)
0.008 (0,20)

4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. This package is hermetically sealed with a ceramic lid using glass frit.
        D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
        E. Falls within MIL STD 1835 GDIP1—T14, GDIP1—T16, GDIP1—T18 and GDIP1—T20.

W (R-GDFP-F20)   **CERAMIC DUAL FLATPACK**

0.300 (7,62)
0.245 (6,22)

Base and Seating Plane

0.045 (1,14)
0.026 (0,66)

0.100 (2,54)
0.045 (1,14)

0.009 (0,23)
0.004 (0,10)

0.320 (8,13) MAX

1   20

0.022 (0,56)
0.015 (0,38)

0.050 (1,27)

0.540 (13,72)
MAX

0.005 (0,13) MIN
4 Places

10   11

0.370 (9,40)
0.250 (6,35)

0.370 (9,40)
0.250 (6,35)

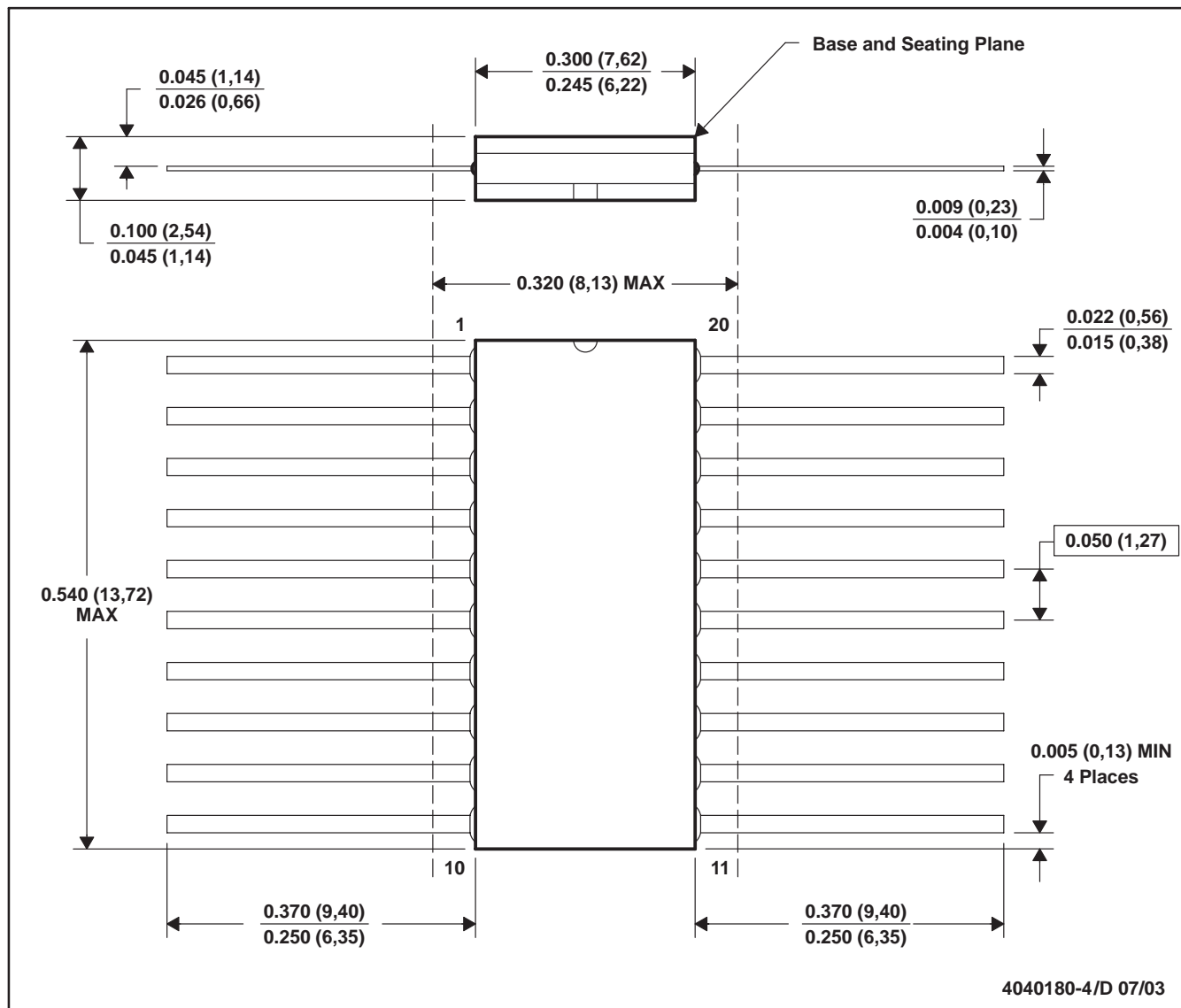4040180-4/D 07/03

NOTES: A. All linear dimensions are in inches (millimeters).
   B. This drawing is subject to change without notice.
   C. This package can be hermetically sealed with a ceramic lid using glass frit.
   D. Index point is provided on cap for terminal identification only.
   E. Falls within Mil-Std 1835 GDFP2-F20

![Texas Instruments logo]
TEXAS INSTRUMENTS

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

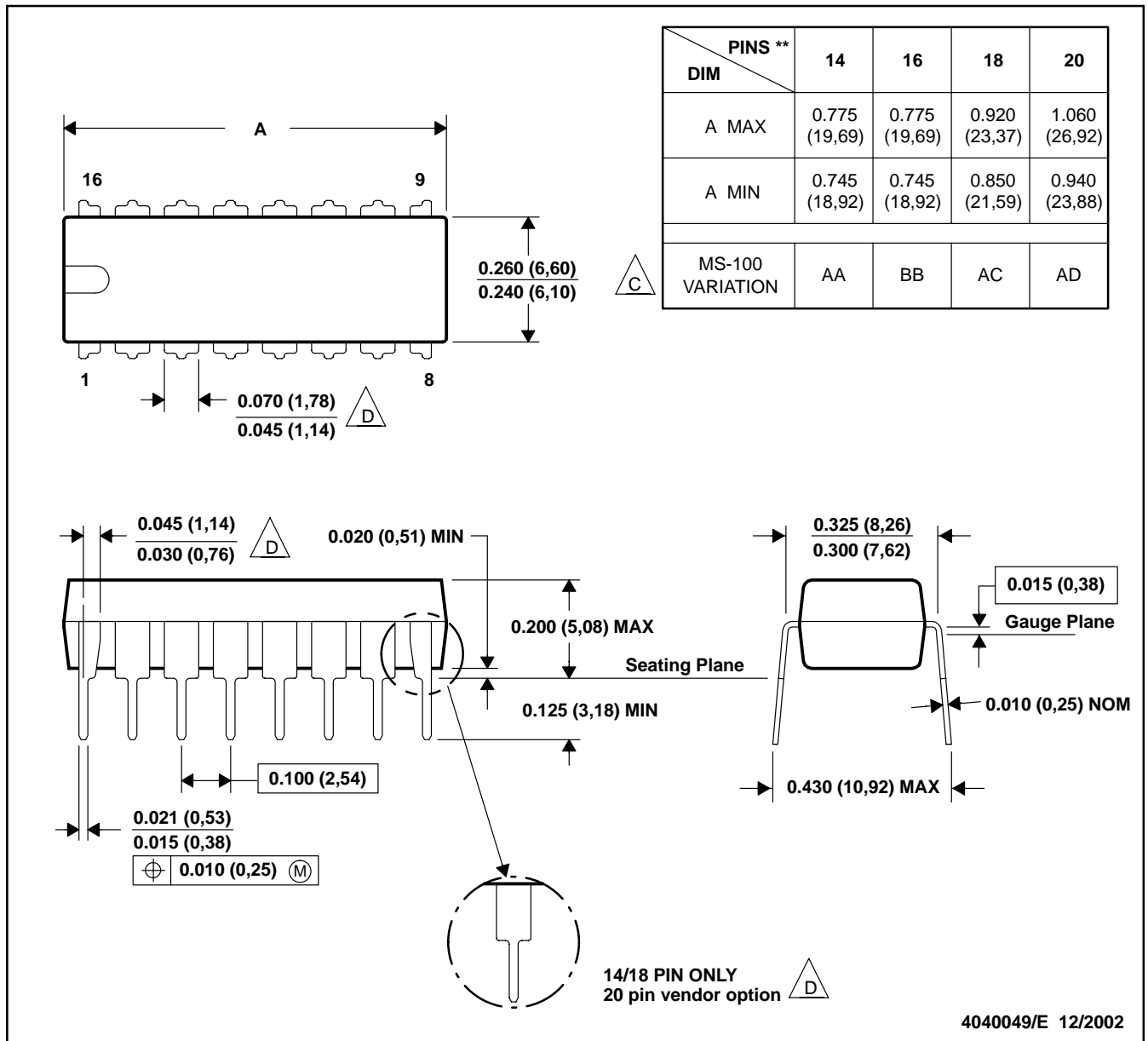| NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

4040140 / D 10/96

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

TEXAS INSTRUMENTS

MECHANICAL

N (R-PDIP-T**)   **PLASTIC DUAL-IN-LINE PACKAGE**

16 PINS SHOWN

PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-100 VARIATION	AA	BB	AC	AD

A

16   9

0.260 (6,60) / 0.240 (6,10)

1   8

0.070 (1,78) / 0.045 (1,14) D

0.045 (1,14) / 0.030 (0,76) D

0.020 (0,51) MIN

0.325 (8,26) / 0.300 (7,62)

0.015 (0,38)
Gauge Plane

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.010 (0,25) NOM

0.100 (2,54)

0.021 (0,53) / 0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

0.430 (10,92) MAX

14/18 PIN ONLY
20 pin vendor option D
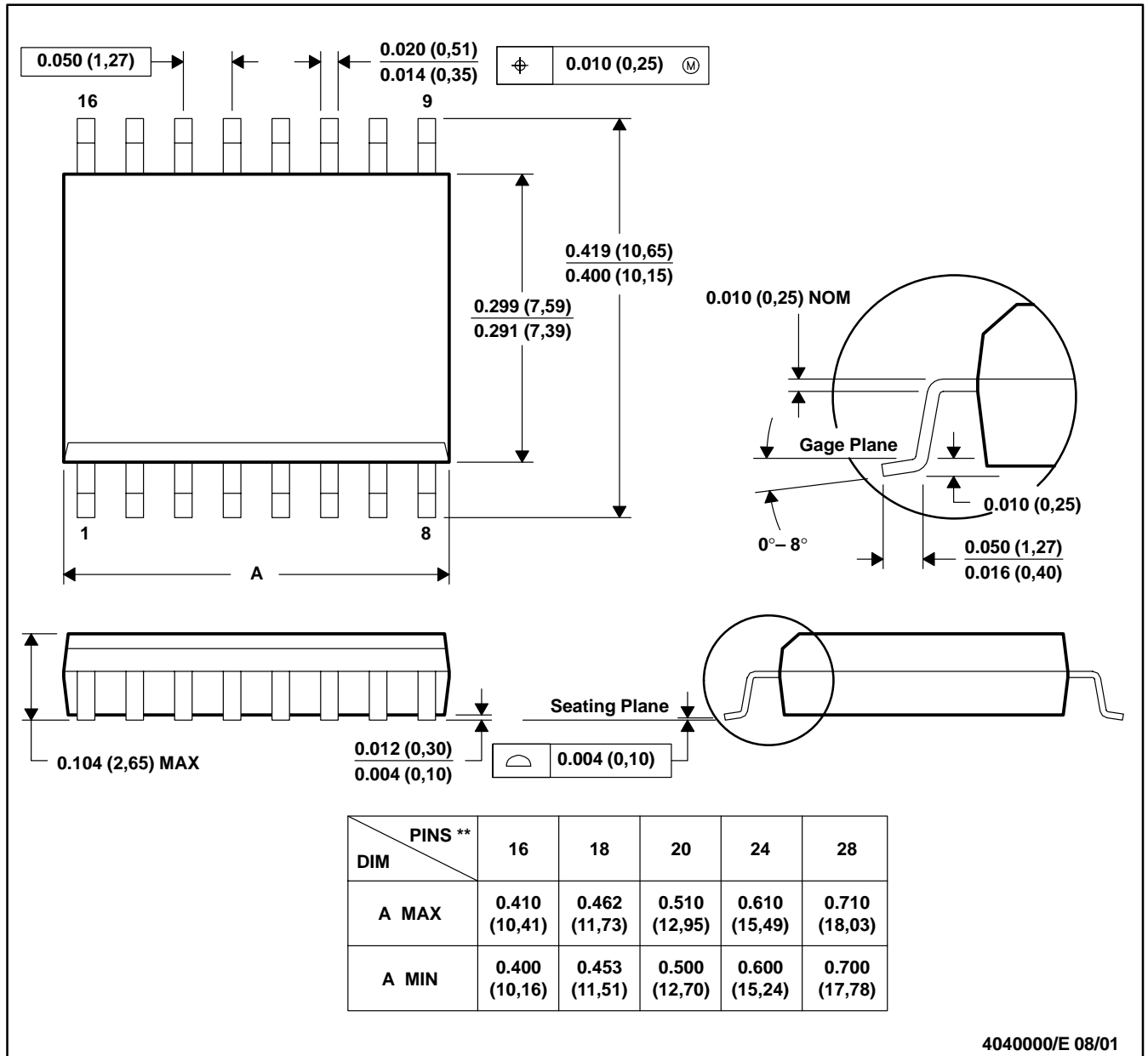
4040049/E 12/2002

NOTES: A. All linear dimensions are in inches (millimeters).
           B. This drawing is subject to change without notice.
           C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body lrngth (Dim A).
           D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G**)　　　　　　　　　　　**PLASTIC SMALL-OUTLINE PACKAGE**

16 PINS SHOWN

0.050 (1,27)

0.020 (0,51)
0.014 (0,35)

⊕ 0.010 (0,25) Ⓜ

16

9

0.419 (10,65)
0.400 (10,15)

0.299 (7,59)
0.291 (7,39)

0.010 (0,25) NOM

Gage Plane

0.010 (0,25)

1

8

0°– 8°

0.050 (1,27)
0.016 (0,40)

A

0.104 (2,65) MAX

0.012 (0,30)
0.004 (0,10)

Seating Plane

⌒ 0.004 (0,10)

PINS **　DIM	16	18	20	24	28
A MAX	0.410 (10,41)	0.462 (11,73)	0.510 (12,95)	0.610 (15,49)	0.710 (18,03)
A MIN	0.400 (10,16)	0.453 (11,51)	0.500 (12,70)	0.600 (15,24)	0.700 (17,78)

4040000/E 08/01

NOTES:　A. All linear dimensions are in inches (millimeters).
　　　　　B. This drawing is subject to change without notice.
　　　　　C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
　　　　　D. Falls within JEDEC MS-013

TEXAS INSTRUMENTS

POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

1

NS (R-PDSO-G)**   PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G**)   **PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN

0,65

0,30
0,19

⊕ 0,10 Ⓜ

14   8

4,50
4,30

6,60
6,20

0,15 NOM

Gage Plane

0°–8°

0,25

0,75
0,50

1   7

A

1,20 MAX

0,15
0,05

Seating Plane

⌒ 0,10

DIM / PINS **	8	14	16	20	24	28
A MAX	3,10	5,10	5,10	6,60	7,90	9,80
A MIN	2,90	4,90	4,90	6,40	7,70	9,60

4040064/F 01/97

NOTES: A. All linear dimensions are in millimeters.
   B. This drawing is subject to change without notice.
   C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
   D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265